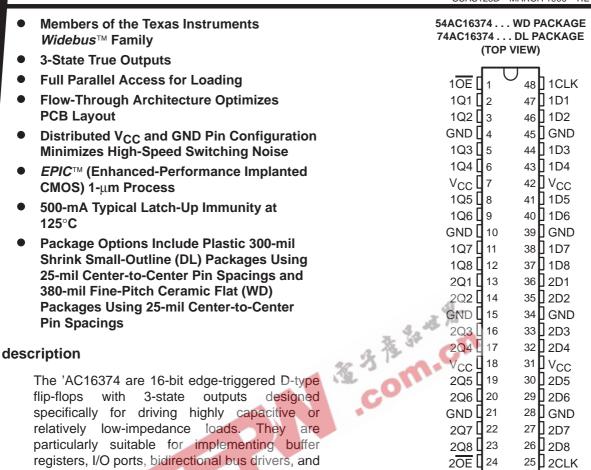
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The 'AC16374 can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly.

OE does not affect the internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The 74AC16374 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54AC16374 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74AC16374 is characterized for operation from -40°C to 85°C.



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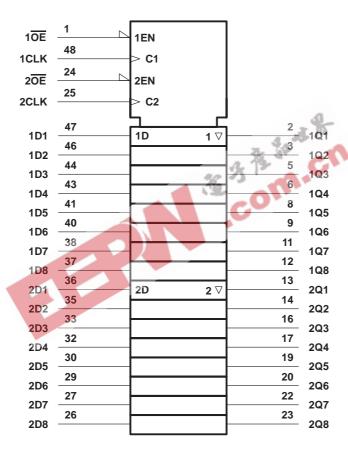
working registers.

54AC16374, 74AC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS SCAS123B - MARCH 1990 - REVISED APRIL 1996

FUNCTION TABLE

	INPUTS	OUTPUT	
OE	CLK	D	Q
L	↑	Н	Н
L	\uparrow	L	L
L	X	Χ	Q ₀
L	\downarrow	Χ	Q ₀ Q ₀
Н	X	Χ	Z

logic symbol†

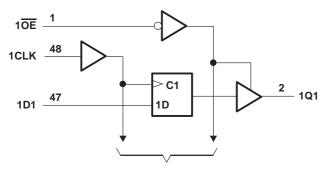


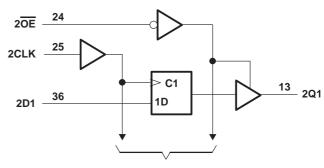
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



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logic diagram (positive logic)





To Seven Other Channels To Seven Other Channels

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power package dissipation at T _A = 55°C (in still air)(see Note 2): DL package	ge 1.2 W
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

54AC16374, 74AC16374 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS SCAS123B - MARCH 1990 - REVISED APRIL 1996

recommended operating conditions (see Note 3)

			54AC16374			74	AC1637	4	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage		3	5	5.5	3	5	5.5	V
		VCC = 3 V	2.1			2.1			
V_{IH}	High-level input voltage	V _{CC} = 4.5 V	3.15			3.15			V
		V _{CC} = 5.5 V	3.85			3.85			
		V _{CC} = 3 V			0.9			0.9	
V _{IL} Low-level input voltage	V _{CC} = 4.5 V		Ĺ	1.35			1.35	V	
		V _{CC} = 5.5 V		3	1.65			1.65	
٧ _I	Input voltage		0	Q	Vcc	0		Vcc	V
٧o	Output voltage		0	,Ó	Vcc	0		Vcc	V
		VCC = 3 V	4	3	-4			-4	
loh	High-level output current	V _{CC} = 4.5 V	S. C.		-24			-24	mA
		V _{CC} = 5.5 V			-24			-24	
		VCC = 3 V			12			12	
IOL	Low-level output current	V _{CC} = 4.5 V		. Ja	24			24	mA
		V _{CC} = 5.5 V	25-	44	24			24	
Δt/Δν	Input transition rise or fall rate		0	h	10	0		10	ns/V
ТД	Operating free-air temperature		-55	30	125	-40		85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V	T,	Δ = 25°C	54AC16374	74AC16374	UNIT
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP MAX	MIN MAX	MIN MAX	UNII
		3 V	2.9		2.9	2.9	
	ΙΟΗ = -50 μΑ	4.5 V	4.4		4.4	4.4	
		5.5 V	5.4		5.4	5.4	
Voн	I _{OH} = -4 mA	3 V	2.58		2.48	2.48	V
		4.5 V	3.94		3.8	3.8	
	$I_{OL} = -24 \text{ mA}$	5.5 V	4.94		4.8	4.8	
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V			3.85	3.85	
		3 V		0.1	0.1	0.1	
	I _{OL} = 50 μA	4.5 V		0.1	0.1	0.1	
		5.5 V		0.1	0.1	0.1	
VOL	I _{OL} = 12 mA	3 V		0.36	0.44	0.44	V
	lo 24 mA	4.5 V		0.36	0.44	0.44	
	I _{OL} = 24 mA	5.5 V		0.36	0.44	0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V			1.65	1.65	
lį	V _I = V _{CC} or GND	5.5 V		±0.1	±1	±1	μΑ
loz	V _O = V _{CC} or GND	5.5 V		±0.5	±5	±5	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V		8	80	80	μΑ
C _i	V _I = V _{CC} or GND	5 V		3			pF
Co	$V_O = V_{CC}$ or GND	5 V		11			pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



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timing requirements over recommended operating free-air temperature range V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

			T _A = 2	25°C	54AC1	6374	74AC1	6374	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency		0	60	0	60	0	60	MHz
t _W	Pulse duration	CLK high or low	8.3		8.3	10,00	8.3		ns
t _{su}	Setup time, data before CLK↑		7.5		7.5	110	7.5		ns
t _h	Hold time, data after CLK↑		0		0		0		ns

timing requirements over recommended operating free-air temperature range V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = :	25°C	54AC1	6374	74AC1	16374	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency		0	100	0	100	0	100	MHz
t _W	Pulse duration	CLK high or low	5		5	100 M	5		ns
t _{su}	Setup time, data before CLK↑		5		5	7/1/2	5		ns
th	Hold time, data after CLK↑		0	J. M	0		0		ns

switching characteristics over recommended operating free-air temperature range V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	ТО	T _A = 25°C		54AC16374		74AC16374		UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f _{max}			60			60	7	60		MHz
t _{PLH}	CLK	Q	4.9	12.2	15	4.9	17	4.9	17	ns
^t PHL	CLK		4.8	11.9	14.3	4.8	15.7	4.8	15.7	115
^t PZH	ŌĒ	Q	4.3	11.9	14.7	4.3	16.8	4.3	16.8	ns
^t PZL	OE	ά	5.3	15.5	18.7	5.3	21.2	5.3	21.2	115
^t PHZ	<u> </u>	Q	4	7.3	9	64	9.8	4	9.8	ns
^t PLZ	ŌĒ	3	3.8	7.1	8.8	3.8	9.4	3.8	9.4	110

switching characteristics over recommended operating free-air temperature range V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

00	•	, ,	•	•						
PARAMETER	FROM	то	T,	T _A = 25°C			54AC16374		74AC16374	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f _{max}			100			100	3	100		MHz
t _{PLH}	CLK	_K Q	3.8	7.6	9.5	3.8	10.8	3.8	10.8	ne
^t PHL	OLK	ų ,	3.8	7.6	9.5	3.8	10.6	3.8	10.6	ns
^t PZH	OE	0	3.2	7.2	9	3.2	10.2	3.2	10.2	ns
t _{PZL}	OE .	Q	3.8	8.7	10.7	3.8	12.1	3.8	12.1	115
^t PHZ	<u> </u>	Q	3.7	6	7.5	3.7	8.2	3.7	8.2	ns
t _{PLZ}	ŌĒ	~	3.5	5.8	7.3	3.5	7.9	3.5	7.9	115

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

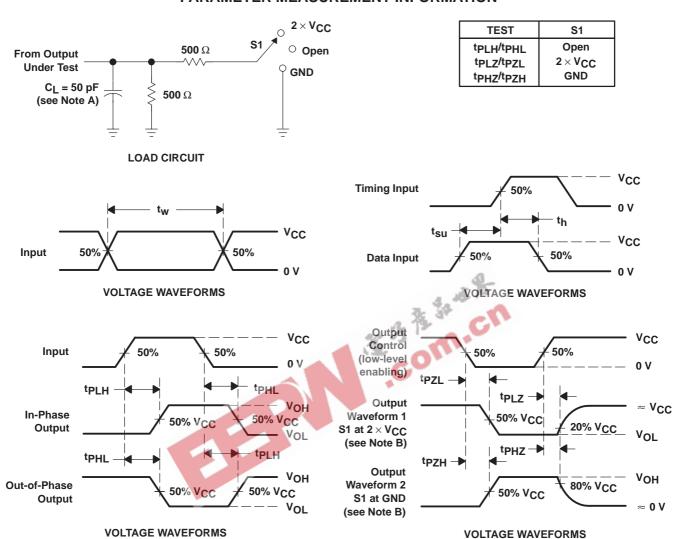
	PARAMETER	TEST CO	TYP	UNIT		
	Dower discipation canacitance per flip flop	Outputs enabled	C 50 pE	f = 1 MHz	49	nE.
Cpd	Power dissipation capacitance per flip-flop	Outputs disabled	$C_L = 50 \text{ pF},$	i = i IVIMZ	32	pF

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50~\Omega$, $t_f = 3~ns$, $t_f = 3~ns$.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

24-Feb-2006

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74AC16374DL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AC16374DLG4	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AC16374DLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74AC16374DLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

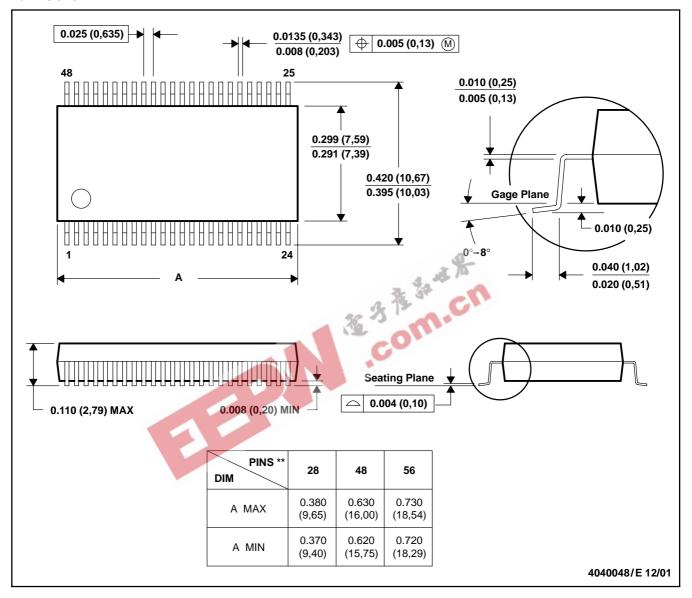
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DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

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